

# High-Speed USB2.0 (480 Mbps) DPDT Switch UM7222MA MSOP10 UM7222 OFN10 1.8×1.4

#### **General Description**

The UM7222MA/UM7222 is a dual port high-speed, low-power data switch optimized for USB 2.0 signal switching. The UM7222MA/UM7222 switch is configured in double-pole/double-throw DPDT. It handles bidirectional signal flow, achieving a 550 MHz -3dB bandwidth, and a port to port crosstalk and isolation at -50dB at 250MHz.

The UM7222MA/UM7222 operates from a single +2.7V to +5.5V supply, with current consumption less than 1 microampere.

The UM7222MA/UM7222 features wide bandwidth and low bit-to-bit skew allow it to pass high-speed differential signal with good signal integrity, offers little or no attenuation of the high-speed signals at the outputs. Its high channel-to-channel crosstalk rejection results in minimal noise interface. Its bandwidth is wide enough to pass high-speed USB 2.0 differential signals (480Mbps). The control logic threshold is guaranteed to be compatible with 1.8V logic.

The UM7222MA is available in Pb-free MSOP10 package, while the UM7222 is available in Pb-free QFN10 package (1.4mm×1.8mm×0.55mm). They are ideal for portable high speed mix signal switching application.

#### **Applications**

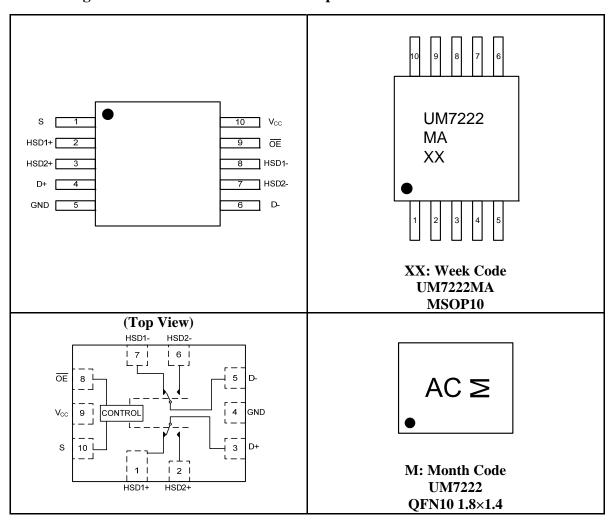
- Differential Signal Data Routing
- USB2.0 Signal Routing
- Cell Phone, PDA, Digital Camera and Notebook
- LCD Monitor, TV and Set-Top Box

#### **Features**

- Ron is Typically  $6.5\Omega$  at  $V_{CC}=3.0V$
- Low Bit-to-Bit Skew: Typically 50ps
- OVT on D+ and D- up to 5.5V
- Power OFF Protection: When V<sub>CC</sub>=0V, D+ and D- can Tolerate up to
- Low Crosstalk: -50dB (250MHz)
- Low Current Consumption: 1μA
- Near-Zero Propagation Delay: 250ps
- Channel On-Capacitance: 6.5pF(Typical)
- $V_{CC}$  Operating Range: +2.7V to +5.5V
- 550MHz Bandwidth (or Data Frequency)
- Lead (Pb)-Free MSOP10 and QFN10 Packages
- ESD Rating: ±4kV I/O to GND

## **Pin Configurations**

# **Top View**



# **Pin Description**

P	Pin		Euro et ar		
UM7222MA	UM7222	- Name	Function		
2	1	HSD1+	Data Ports		
3	2	HSD2+	Data Ports		
4	3	D+	Data Ports		
5	4	GND	Ground Connection		
6	5	D-	Data Ports		
7	6	HSD2-	Data Ports		
8	7	HSD1-	Data Ports		
9	8	ŌĒ	Output Enable		
10	9	V <sub>CC</sub>	Positive Supply Voltage		
1	10	S	Select Input		

# **Ordering Information**

Part Number	Packaging Type	Marking Code	Shipping Qty
UM7222MA	MSOP10	UM7222MA	3000pcs/13 Inch Tape & Reel
UM7222	QFN10 1.8×1.4	AC	3000pcs/7 Inch Tape & Reel

# **Function Table**

<del>OE</del>	S	HSD1+, HSD1-	HSD2+, HSD2-
1	X	OFF	OFF
0	0	ON	OFF
0	1	OFF	ON

# **Absolute Maximum Ratings**

Symbol	Parameter	Limit	Unit
$V_{CC}$	Supply Voltage	-0.5 to +6.5	
V <sub>IS</sub>	Analog Switch Input Voltage	-0.5 to +6.5	V
$V_{\rm IN}$	Digital Select Input Voltage	-0.5 to +6.5	
$I_D$	Continuous DC Current	50	mA
$P_{D}$	Power Dissipation	0.5	W
To	Operating Temperature Range	-40 to +85	°C
$T_{STG}$	Storage Temperature Range	-65 to +150	C

## **DC Electrical Characteristics**

	_	Test	V <sub>CC</sub>	_	Limits (-40°C to 85°C)			
Symbol	Parameter	Conditions	( <b>V</b> )	Temp	Min	Typ (Note1)	Max	Unit
$I_{IN}$	Input Leakage Current	$0 \le V_{IS} \le V_{CC}$	3.6	Full	-1.0		1.0	μΑ
I <sub>OFF</sub>	Power Off Leakage Current	$0 \le V_{IS} \le V_{CC}$	0	Full	-1.0		1.0	μΑ
$I_{CCT}$	Increase in I <sub>CC</sub> per Control Voltage	V <sub>IN</sub> =2.6V	3.6	Full			10	μΑ
$I_{OZ}$	OFF State Leakage Current	$0 \le V_{IS} \le V_{CC}$	3.6	Full	-1.0		1.0	μΑ
$I_{CC}$	Quiescent Supply Current	$ m V_{IS}=V_{CC}$ or GND	3.6	Full			1.0	μΑ
$V_{\mathrm{IH}}$	Input High Voltage		3.0 to 3.6	Full	1.3			V
$V_{ m IL}$	Input Low Voltage		3.0 to 3.6	Full			0.5	V
$V_{IK}$	Clamp Diode Voltage	$I_{IS}$ =-18mA	3.0	Full			-1.2	V
R <sub>ON</sub>	On-Resistance (Note 2)	$V_{IS}$ =0 to 0.4V $I_{D}$ =8mA	3.0	Full		6.5	9	Ω
$\Delta R_{\mathrm{ON}}$	On Resistance Match Between Channels (Note 2, 3)	$V_{IS}$ =0 to 0.4V $I_D$ =8mA	3.0	Full		0.35		Ω
$R_{FLAT}$	On Resistance Flatness (Note 2, 3)	$V_{IS}$ =0 to 1.0V $I_{D}$ =8mA	3.0	Full		4.5		Ω

Note 1: Typically values are at  $V_{CC}$ =3.3V and  $T_A$ =+25°C. Note 2: Guaranteed by design. Resistance measurements do not include test circuit or package resistance.

Note 3: Parameter is characterized but not tested in production.

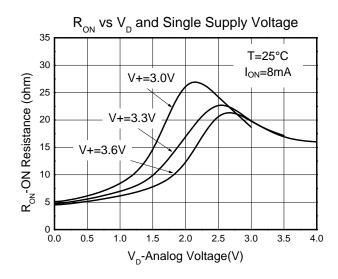
## **AC Electrical Characteristics**

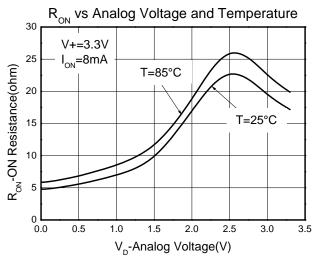
Camab al	Parameter	Test	$\mathbf{v}_{\mathbf{cc}}$	Tomn	Limits (-40°C to 85°C)			Unit	
Symbol	rarameter	Conditions	<b>(V)</b>	Temp	Min	Typ (Note1)	Max		
$t_{ON}$	Turn On Time	$V_{IS}=0.8V$	3.0 to 3.6	Full		13	30	ns	
$t_{ m OFF}$	Turn Off Time	$V_{IS}=0.8V$	3.0 to 3.6	Full		12	25	ns	
t <sub>BBM</sub>	Break Before Make Time (Note 4)	V <sub>IS</sub> =0.8V	3.0 to 3.6	Full	2	4.7	6.5	ns	
$t_{\mathrm{PD}}$	Propagation Delay	$C_L=10pF$	3.0 to 3.6	Full		0.25		ns	
t <sub>SK(O)</sub>	Channel to Channel Skew	C <sub>L</sub> =10pF	3.0 to 3.6			0.05		ns	
$O_{IRR}$	Off Isolation	$R_L$ =50 $\Omega$ , f=250MHz	3.0 to 3.6	Full		-25		dB	
$X_{TALK}$	Crosstalk	$R_L$ =50 $\Omega$ , f=250MHz	3.0 to 3.6	Full		-48		dB	
BW	-3dB Bandwidth	$R_L=50\Omega$	3.0 to 3.6	Full		550		MHz	
Capacita	ince								
C <sub>IN</sub>	Control Pin Input Capacitance (Note 5)	V <sub>CC</sub> =0V				2.5		pF	
$C_{OFF}$	HSD+ HSD- Off Capacitance (Note 5)	$V_{\text{CC}}=V_{\text{IS}}=3.3\text{V},$ $OE=3.3\text{V}$			_	4.5	_	pF	
C <sub>ON</sub>	HSD+ HSD- ON Capacitance (Note 5)	V <sub>CC</sub> =3.3V, OE=0V				7.0		pF	

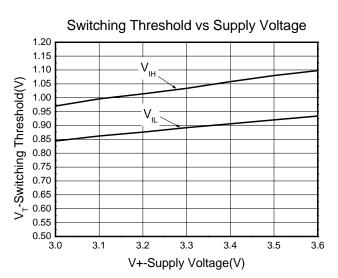
Note 4: Guaranteed by design.

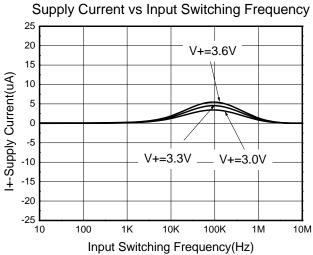
Note 5: T<sub>A</sub>=+25°C, f=1MHz, Capacitance is characterized but not tested in production.

## **Typical Performance Characteristics**





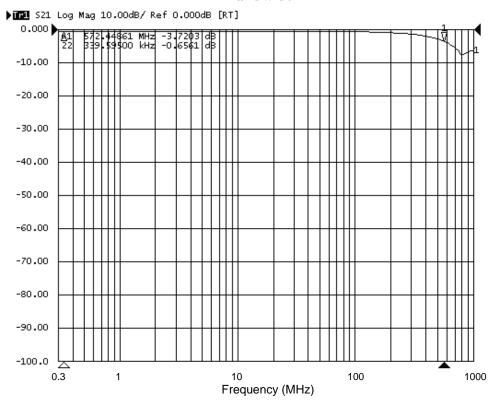




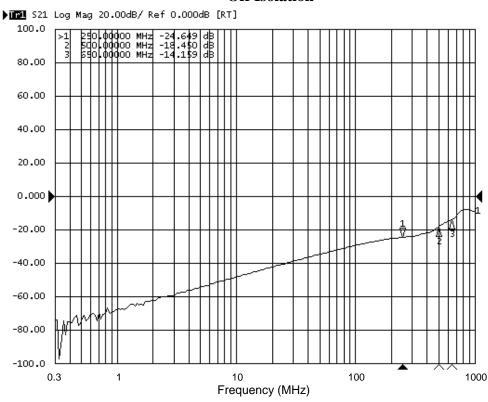


# **Typical Performance Characteristics (Continued)**

#### **Bandwidth**



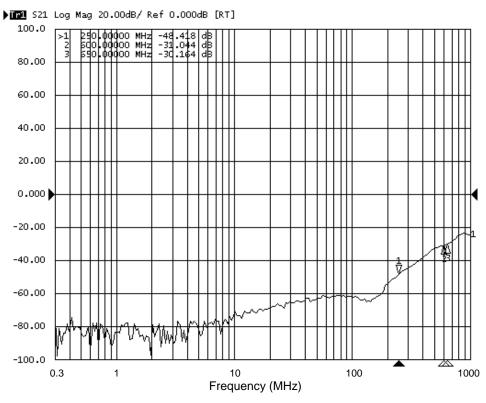
#### **Off Isolation**



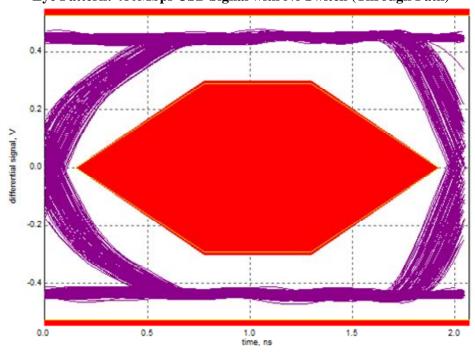


# **Typical Performance Characteristics (Continued)**

#### Crosstalk



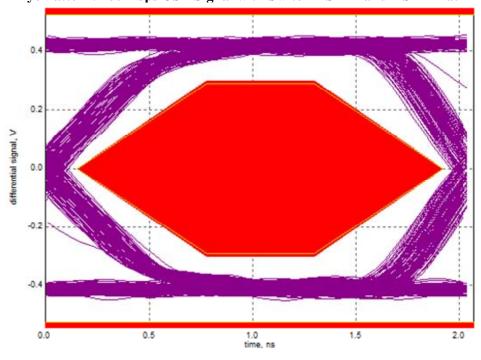
# Eye Pattern: 480Mbps USB Signal with No Switch (Through Path)



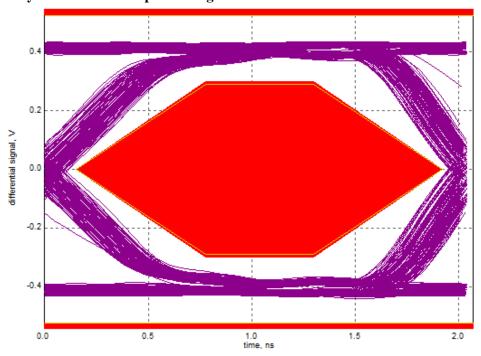


# **Typical Performance Characteristics (Continued)**

Eye Pattern: 480Mbps USB Signal with Switch HSD1+ and HSD1- Path



Eye Pattern: 480Mbps USB Signal with Switch HSD2+ and HSD2- Path





# **Applications Information**

#### **Power-Off Protection**

For a VBUS short circuit, the switch is expected to withstand such a condition for at least 24 hours. The UM7222 has specially designed circuitry which prevents unintended signal bleed through as well as guaranteed system reliability during a power-down, over-voltage condition. The protection has been added to the common pins (D+, D-).

#### **Power-On Protection**

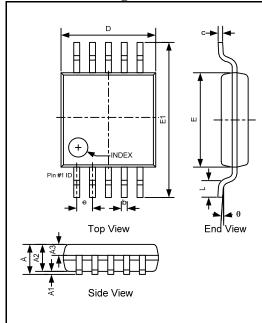
The USB 2.0 specification also notes that the USB device should be capable of withstanding a VBUS short during transmission of data. This modification works by limiting current flow back into the V+ rail during the over-voltage event so current remains within the safe operating range. In this application, the switch passes the full 5.25V input signal through to the selected output while maintaining specified off isolation on the un-selected pins.



# **Package Information**

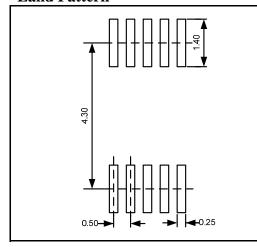
## **UM7222MA MSOP10**

**Outline Drawing** 



DIMENSIONS								
Cb al	MILLIMETERS			INCHES				
Symbol	Min	Тур	Max	Min	Тур	Max		
A	-	1	1.10	-	-	0.043		
A1	0.00	-	0.15	0.000	-	0.006		
A2	0.75	0.85	0.95	0.030	0.033	0.037		
A3	0.25	0.35	0.39	0.010	0.014	0.015		
b	0.18	-	0.28	0.007	-	0.011		
c	0.09	-	0.23	0.004	•	0.009		
D	2.90	3.00	3.10	0.114	0.118	0.122		
Е	2.90	3.00	3.10	0.114	0.118	0.122		
E1	4.70	4.90	5.10	0.185	0.193	0.201		
e	0.50BSC			0	.020BS	C		
L	0.40	0.60	0.80	0.016	0.024	0.031		
θ	0°	-	8°	0°	-	8°		

## **Land Pattern**



#### NOTES:

- 1. Compound dimension: 3.00×3.00;
- 2. Unit: mm;
- 3. General tolerance  $\pm 0.05$ mm unless otherwise specified;
- 4. The layout is just for reference.

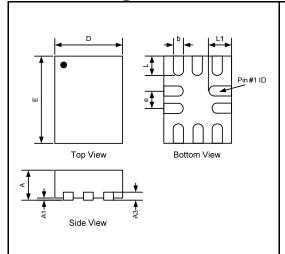
## **Tape and Reel Orientation**





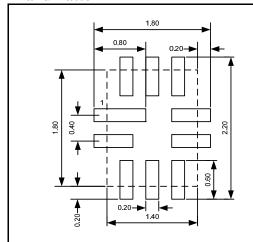
# UM7222 QFN10 1.8×1.4

# **Outline Drawing**



DIMENSIONS								
Cb al	MILLIMETERS			INCHES				
Symbol	Min	Тур	Max	Min	Тур	Max		
A	0.50	0.55	0.60	0.020	0.022	0.024		
A1	0.00	ı	0.05	0.000	•	0.002		
A3	(	).15RE	F	0.006REF				
b	0.15	0.20	0.25	0.006	0.008	0.010		
D	1.35	1.40	1.45	0.053	0.055	0.057		
Е	1.75	1.80	1.85	0.069	0.071	0.073		
e	0.40BSC			0	.016BS0	$\mathbb{C}$		
L	0.30	0.40	0.50	0.012	0.016	0.020		
L1	0.40	0.50	0.60	0.016	0.020	0.024		

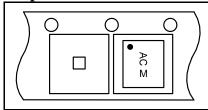
# **Land Pattern**



#### NOTES:

- 1. Compound dimension: 1.80×1.40;
- 2. Unit: mm
- 3. General tolerance  $\pm 0.05$ mm unless otherwise specified;
- 4. The layout is just for reference.

# **Tape and Reel Orientation**





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